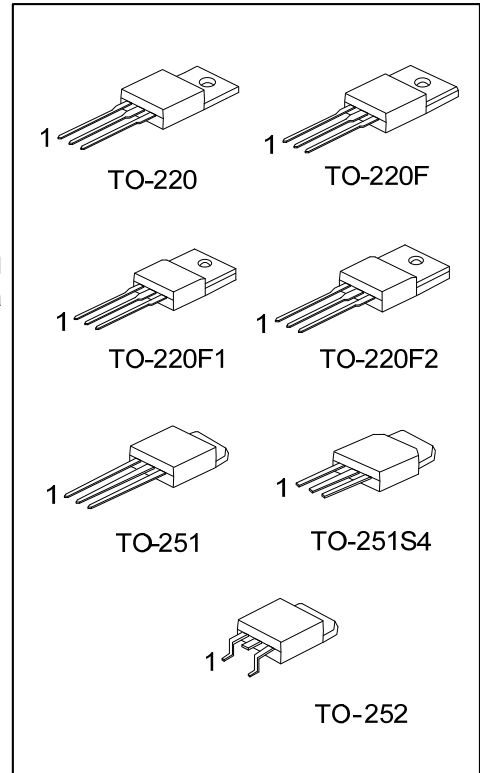
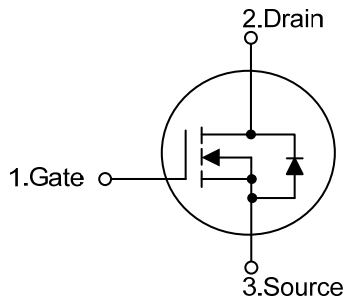


**3N80****Power MOSFET****3.0A, 800V N-CHANNEL
POWER MOSFET****DESCRIPTION**

The UTC **3N80** provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

FEATURES

- * $R_{DS(ON)} < 4.2\Omega$ @ $V_{GS} = 10\text{ V}$
- * Ultra Low Gate Charge (typical 19 nC)
- * Low Reverse Transfer Capacitance ($C_{RSS} = \text{Typical } 11\text{ pF}$)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

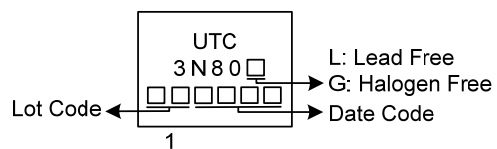
SYMBOL**ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
3N80L-TA3-T	3N80G-TA3-T	TO-220	G	D	S	Tube
3N80L-TF3-T	3N80G-TF3-T	TO-220F	G	D	S	Tube
3N80L-TF1-T	3N80G-TF1-T	TO-220F1	G	D	S	Tube
3N80L-TF2-T	3N80G-TF2-T	TO-220F2	G	D	S	Tube
3N80L-TM3-T	3N80G-TM3-T	TO-251	G	D	S	Tube
3N80L-TMS4-T	3N80G-TMS4-T	TO-251S4	G	D	S	Tube
3N80L-TN3-R	3N80G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

3N80G-TA3-T (1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TMS4: TO-251S4, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage ($V_{GS}=0\text{V}$)		V_{DSS}	800	V
Drain-Gate Voltage ($R_G=20\text{k}\Omega$)		V_{DGR}	800	V
Gate-Source Voltage		V_{GSS}	± 30	V
Gate-Source Breakdown Voltage ($I_{GS}=\pm 1\text{mA}$)		BV_{GSO}	30 (MIN)	V
Insulation Withstand Voltage (DC)	TO-220F/ TO-220F1	V_{ISO}	2500	V
Avalanche Current (Note 2)		I_{AR}	3	A
Continuous Drain Current		I_D	3	A
Pulsed Drain Current		I_{DM}	10	A
Single Pulse Avalanche Energy (Note 3)		E_{AS}	170	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation	TO-220	P_D	70	W
	TO-220F/ TO-220F1 TO-220F2		25	W
	TO-251/TO-251S4 TO-252		50	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by $T_{J(MAX)}$.

3. Starting $T_J=25^{\circ}\text{C}$, $I_D=I_{AR}$, $V_{DD}=50\text{V}$

4. $I_{SD} \leq 2.5\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, $T_J \leq T_{J(MAX)}$.

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-251/TO-251S4 TO-252		110	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220	θ_{JC}	1.78	$^{\circ}\text{C}/\text{W}$
	TO-220F/ TO-220F1 TO-220F2		5	$^{\circ}\text{C}/\text{W}$
	TO-251/TO-251S4 TO-252		2.5	$^{\circ}\text{C}/\text{W}$

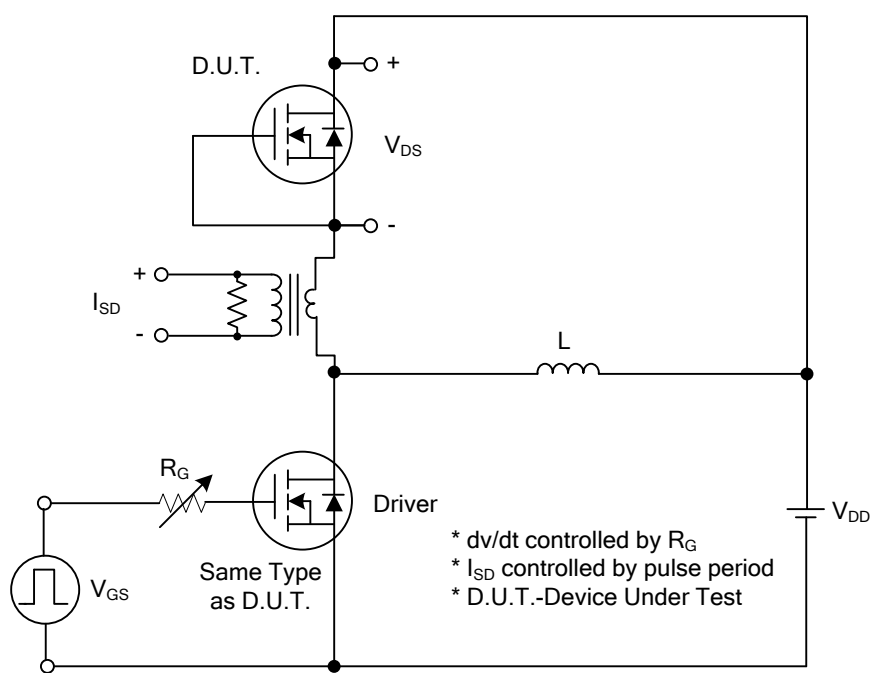
■ **ELECTRICAL CHARACTERISTICS** ($T_C=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	800			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=800V, V_{GS}=0V$			1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30V, V_{DS}=0V$			± 10	μA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	3.0		5.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=1.5A$		3.2	4.2	Ω
Forward Transconductance (Note 1)	g_{FS}	$V_{DS}=15V, I_D=1.5A$		2.1		S
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{DS}=25V, V_{GS}=0V, f=1MHz$		485		pF
Output Capacitance	C_{OSS}			57		pF
Reverse Transfer Capacitance	C_{RSS}			11		pF
Equivalent Output Capacitance (Note 2)	$C_{OSS(EQ)}$	$V_{GS}=0V, V_{DS}=0V\sim 640V$		22		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge	Q_G	$V_{DD}=640V, I_D=3A, V_{GS}=10V$		19		nC
Gate-Source Charge	Q_{GS}			3.2		nC
Gate-Drain Charge	Q_{DD}			10.8		nC
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=400V, I_D=3A, R_G=4.7\Omega$ $V_{GS}=10V$		17		ns
Turn-On Rise Time	t_R			27		ns
Turn-Off Delay Time	$t_{D(OFF)}$			36		ns
Turn-Off Fall Time	t_F			40		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Source-Drain Current	I_{SD}				2.5	A
Source-Drain Current (Pulsed)	I_{SDM}				10	A
Reverse Recovery Current	I_{RRM}	$I_{SD}=3A, di/dt=100A/\mu s,$ $V_{DD}=50V, T_J=25^\circ C$		8.4		A
Diode Forward Voltage(Note 1)	V_{SD}	$I_{SD}=3A, V_{GS}=0V$			1.6	V
Body Diode Reverse Recovery Time	t_{rr}			384		ns
Body Diode Reverse Recovery Charge	Q_{rr}			1600		nC

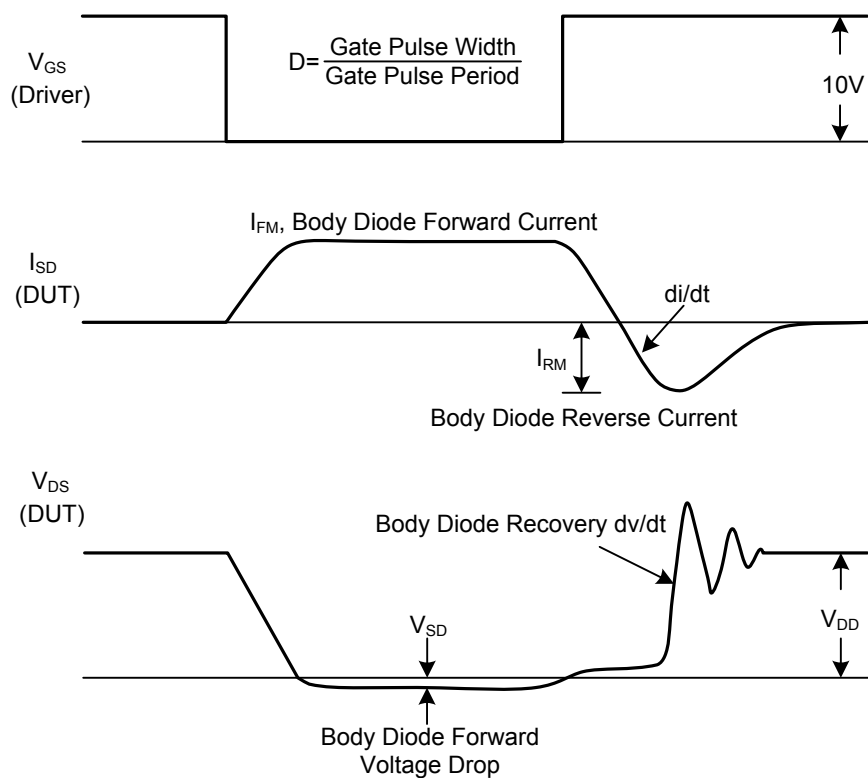
Note: 1. Pulse width = 300 μs , Duty cycle $\leq 1.5\%$.

2. $C_{OSS(EQ)}$ is defined as constant equivalent capacitance giving the same charging time as C_{OSS} when V_{DS} increases from 0 to 80% V_{DSS} .

■ TEST CIRCUITS AND WAVEFORMS

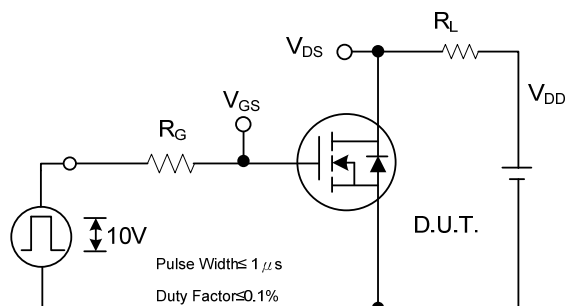


Peak Diode Recovery dv/dt Test Circuit

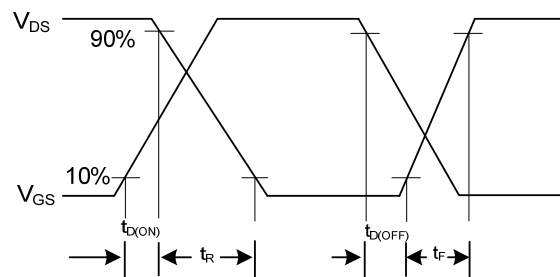


Peak Diode Recovery dv/dt Waveforms

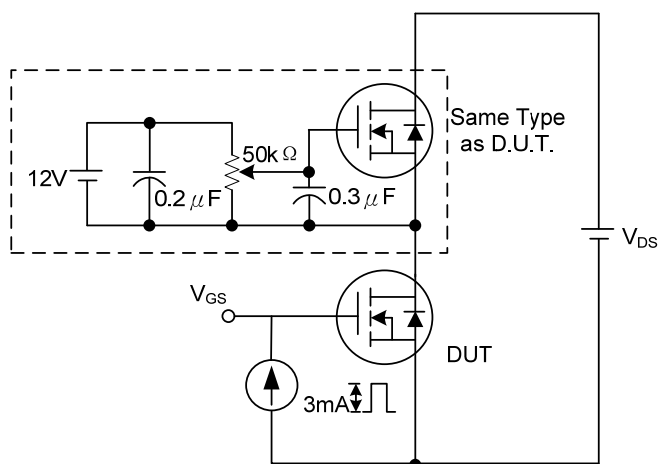
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



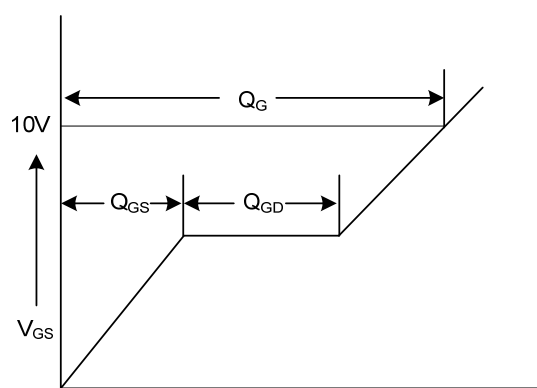
Switching Test Circuit



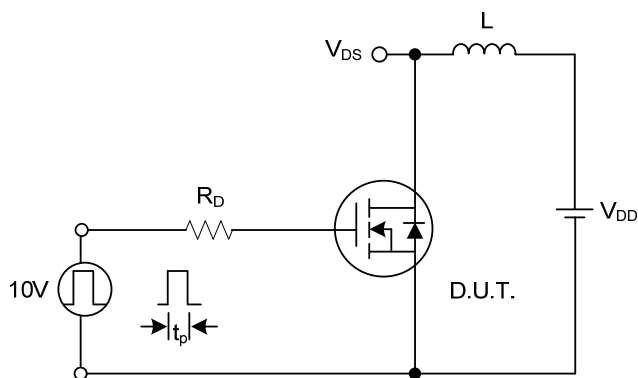
Switching Waveforms



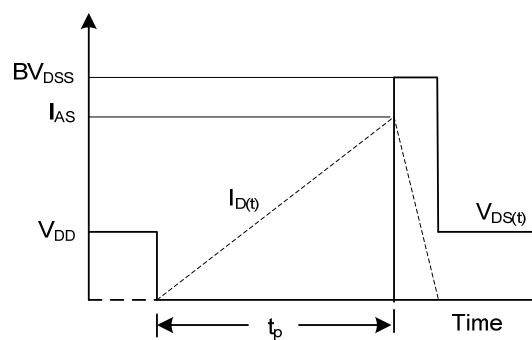
Gate Charge Test Circuit



Charge
Gate Charge Waveform

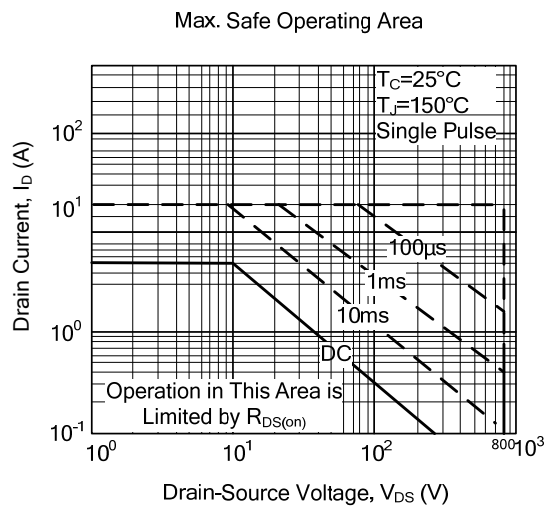
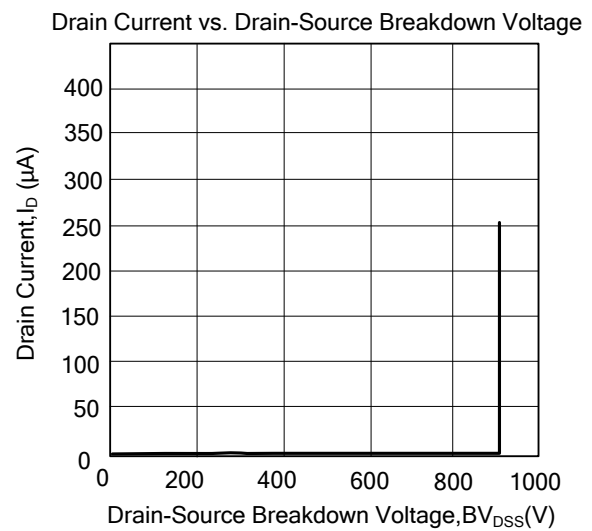
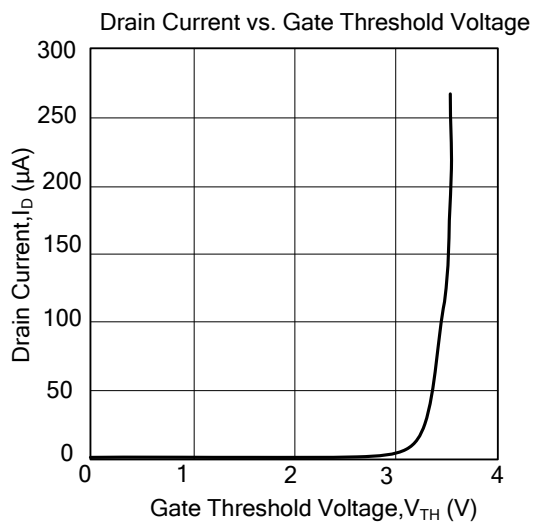
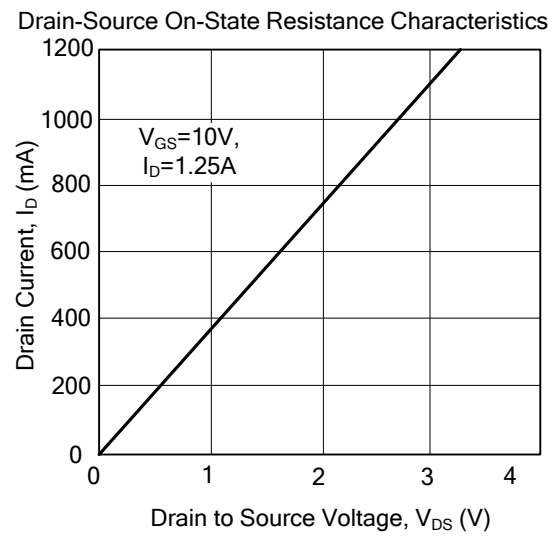
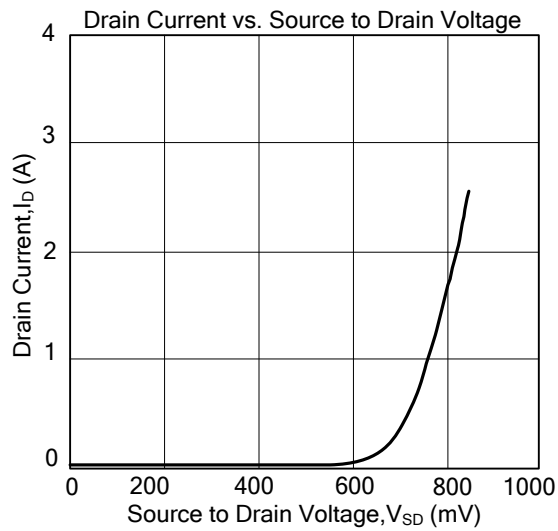


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

TYPICAL CHARACTERISTICS



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